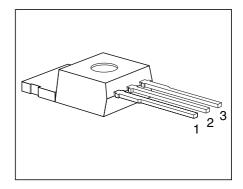


Features

- N channel
- Logic level
- Enhancement mode
- Temperature sensor with thyristor characteristic
 The drain pin is electrically shorted to the tab



Pin	1	2	3
	G	D	S

Туре	V _{DS}	ID	R _{DS(on)}	Package	Ordering Code
BTS 132	60 V	24 A	0.065 Ω	TO-220AB	C67078-A5003-A4

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	V _{DS}	60	V
Drain-gate voltage, $R_{\rm GS}$ = 20 k Ω	$V_{\rm DGR}$	60	
Gate-source peak voltage, aperiodic	$V_{ m gs}$	± 20	
Gate-source voltage	V _{GS}	± 10	
Continuous drain current, $T_{\rm C}$ = 25 °C	ID	24	Α
ISO drain current $T_{\rm C}$ = 85 °C, $V_{\rm GS}$ = 10 V, $V_{\rm DS}$ = 0.5 V	I _{D-ISO}	6.0	
Pulsed drain current, $T_{\rm C} = 25 ^{\circ}{\rm C}$	I _{D puls}	96	
Short circuit current, $T_j = -55 \dots + 150 \text{ °C}$	I _{SC}	80	
Short circuit dissipation, $T_j = -55 \dots + 150 \text{ °C}$	P _{SCmax}	1200	W
Power dissipation	P _{tot}	75	
Operating and storage temperature range	$T_{\rm j}$, $T_{\rm stg}$	- 55 + 150	°C
DIN humidity category, DIN 40 040	_	E	-
IEC climatic category, DIN IEC 68-1	-	55/150/56	
Thermal resistance			K/W
Chip-case Chip-ambient	$R_{ m th~JC} \ R_{ m th~JA}$	≤ 1.67 ≤ 75	



Electrical Characteristics

at $T_{\rm j}$ = 25 °C, unless otherwise specified.

Parameter	Symbol		Values		Unit
		min.	typ.	max.	

Static Characteristics

Drain-source breakdow $V_{\rm GS}$ = 0, $I_{\rm D}$ = 0.25 mA	wn voltage	$V_{\rm (BR)DSS}$	60	_	_	V
Gate threshold voltage $V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 1 \text{ mA}$)	$V_{\rm GS(th)}$	1.5	2.0	2.5	
Zero gate voltage drai $V_{GS} = 0 V, V_{DS} = 60 V$	n current	I _{DSS}				μA
	$T_{\rm j}$ = 25 °C $T_{\rm j}$ = 125 °C		-	1 100	10 300	
Gate-source leakage of $V_{GS} = 20 \text{ V}, V_{DS} = 0$	current	I _{GSS}				
	$T_{\rm j}$ = 25 °C $T_{\rm j}$ = 150 °C			10	100	nA μA
Drain-source on-state $V_{\rm GS}$ = 4.5 V, $I_{\rm D}$ =12 A	resistance	R _{DS(on)}	_	0.055	0.065	Ω

Dynamic Characteristics

Forward transconductance	g _{fs}				S
$V_{\text{DS}} \ge 2 \times I_{\text{D}} \times R_{\text{DS(on)max}}, I_{\text{D}} = 12 \text{ A}$		12	17	22	
Input capacitance	$C_{\rm iss}$				pF
$V_{\rm GS} = 0, V_{\rm DS} = 25 \text{ V}, f = 1 \text{ MHz}$		800	1050	1400	
Output capacitance	C _{oss}				
$V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, f = 1 MHz		-	500	750	
Reverse transfer capacitance	$C_{\rm rss}$				
$V_{\rm GS} = 0, \ V_{\rm DS} = 25 \ V, f = 1 \ MHz$		-	200	300	
Turn-on time t_{on} , $(t_{on} = t_{d(on)} + t_r)$	t _{d(on)}	_	25	40	ns
$V_{\rm CC} = 30 \text{ V}, V_{\rm GS} = 5 \text{ V}, I_{\rm D} = 3 \text{ A}, R_{\rm GS} = 50 \Omega$	t _r	-	150	200	
Turn-off time t_{off} , $(t_{off} = t_{d(off)} + t_{f})$	t _{d(off)}	-	180	250	
$V_{\rm CC} = 30 \text{ V}, V_{\rm GS} = 5 \text{ V}, I_{\rm D} = 3 \text{ A}, R_{\rm GS} = 50 \Omega$	t _f	-	125	160	



Electrical Characteristics (cont'd)

at $T_i = 25 \,^{\circ}$ C, unless otherwise specified.

Parameter	Symbol		Values		Unit
		min.	typ.	max.	

Reverse Diode

Continuous source current	Is	_	-	24	A
Pulsed source current	I _{SM}	_	_	96	
Diode forward on-voltage $I_{\rm F}$ = 24 A, $V_{\rm GS}$ = 0 V	$V_{ m SD}$	_	1.3	1.8	V
Reverse recovery time $I_{\rm F} = I_{\rm S}, {\rm d}i_{\rm F}/{\rm d}t = 100 {\rm A}/{\rm \mu s}, V_{\rm R} = 30 {\rm V}$	t _{rr}	_	150	_	ns
Reverse recovery charge $I_{\rm F} = I_{\rm S}, {\rm d}i_{\rm F}/{\rm d}t = 100 {\rm A}/{\rm \mu s}, V_{\rm R} = 30 {\rm V}$	Qrr	_	1.0	_	μC

Temperature Sensor

Forward voltage	$V_{ m TS(on)}$				V
$I_{\text{TS(on)}} = 5 \text{ mA}, T_j = -55 \dots + 150 \text{ °C}$		-	1.3	1.4	
Sensor override, $t_p \le 100 \ \mu s$ $T_j = -55 \ + 160 \ ^{\circ}C$		_	_	10	
Forward current $T_{\rm j} = -55 \dots + 150 ^{\circ}{\rm C}$ Sensor override, $t_{\rm p} \le 100 \mu{\rm s}$	I _{TS(on)}	_	_	5	mA
$T_{\rm j} = -55 \dots + 160 ^{\circ}{\rm C}$		_	_	600	
Holding current, $V_{TS(off)} = 5 V$, $T_j = 2$ $T_j = 1$	25 °C <i>I</i> _H 150 °C	0.05 0.05	0.1 0.2	0.5 0.3	
Switching temperature $V_{\text{TS}} = 5 \text{ V}$	$T_{TS(on)}$	150	_	_	°C
Turn-off time $V_{\text{TS}} = 5 \text{ V}, I_{\text{TS(on)}} = 2 \text{ mA}$	t _{off}	0.5	_	2.5	μs

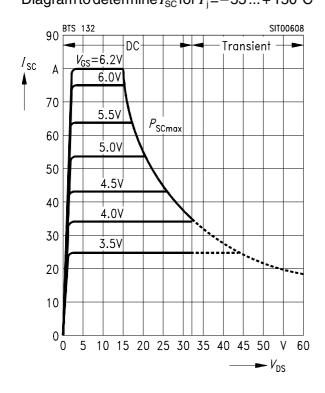


Examples for short-circuit protection

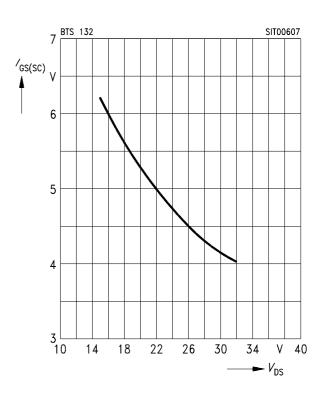
at $T_i = -55 \dots + 150 \text{ °C}$, unless otherwise specified.

Parameter	Symbol	Examples			Unit
		1	2	-	
Drain-source voltage	V_{DS}	15	30	_	V
Gate-source voltage	V _{GS}	6.2	4.1	_	
Short-circuit current	I _{SC}	≤ 80	≤ 37	_	А
Short-circuit dissipation	P _{SC}	1200	1100	_	W
Response time $T_{\rm j}$ = 25 °C, before short circuit	t _{SC(off)}	25	25	_	ms

Short-circuit protection $I_{SC} = f(V_{DS})$ Parameter: V_{GS} Diagram to determine I_{SC} for $T_i = -55 \dots + 150$ °C

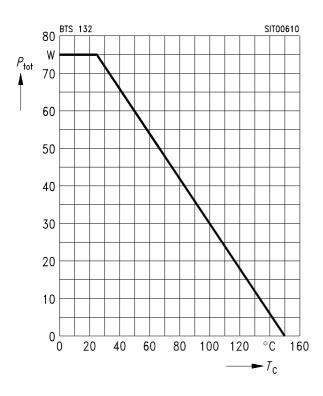


Max. gate voltage $V_{GS(SC)} = f(V_{DS})$ Parameter: $T_j = -55 \dots + 150 \text{ °C}$

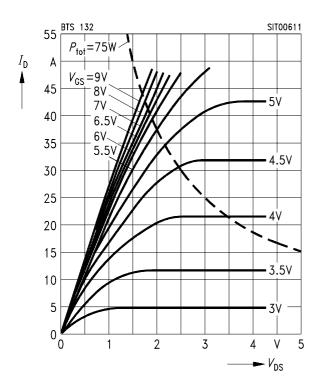




Max. power dissipation $P_{\text{tot}} = f(T_{\text{C}})$

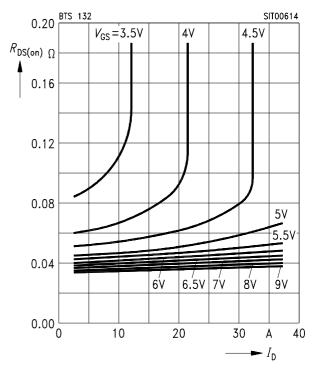


Typical output characteristics $I_{D} = f(V_{DS})$ Parameter: $t_{p} = 80 \ \mu s$

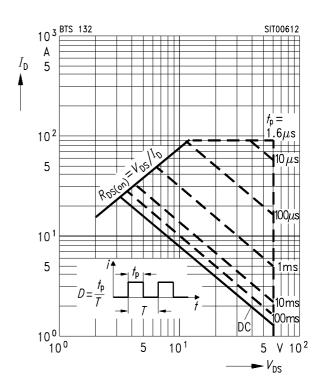


Typ. drain-source on-state resistance $R_{\text{DS(on)}} = f(I_{\text{D}})$

Parameter: $V_{\rm GS}$



Safe operating area $I_{\rm D} = f(V_{\rm DS})$ Parameter: D = 0.01, $T_{\rm C} = 25 \ ^{\circ}{\rm C}$

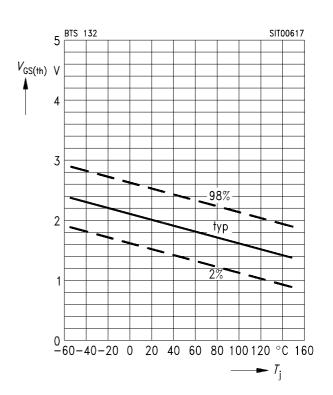




Drain-source on-state resistance

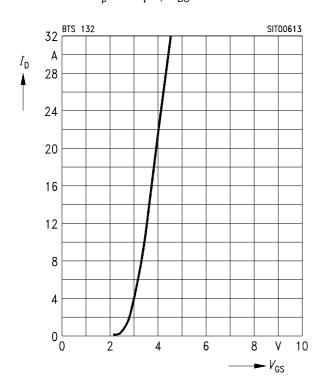
$R_{\rm DS(on)} = f(T_{\rm i})$ Parameter: $I_D = 12 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ (spread) 0.15 BTS 132 SIT00615 $R_{\rm DS(on)}^{\Omega}$ 0.10 98% typ 0.05 0.00 └─ _80 -40 0 40 80 120 °C 160 ► 7_i

Gate threshold voltage $V_{GS(th)} = f(T_j)$ Parameter: $V_{DS} = V_{GS}$, $I_D = 1$ mA

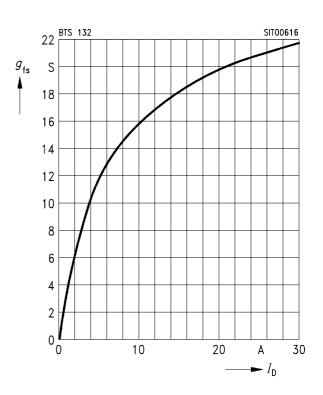


Typ. transfer characteristic

 $I_{\rm D} = f(V_{\rm GS})$ Parameter: $t_{\rm p} = 80 \ \mu \text{s}, V_{\rm DS} = 25 \ \text{V}$



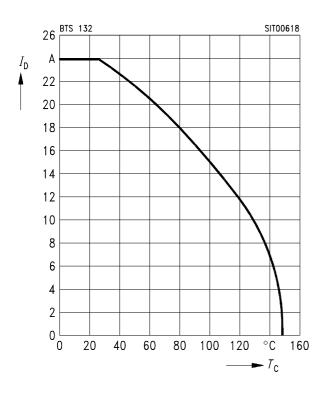
Typ. transconductance $g_{fs} = f(I_D)$ Parameter: $t_p = 80 \ \mu s$, $V_{DS} = 25 \ V$





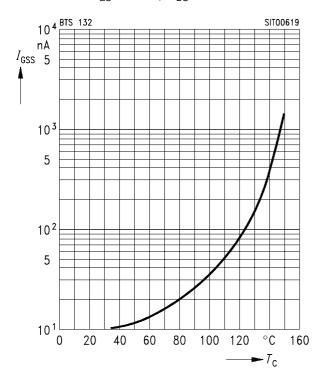
Continuous drain current $I_{\rm D} = f(T_{\rm C})$

Parameter: $V_{\rm GS} \ge 4.5 \text{ V}$



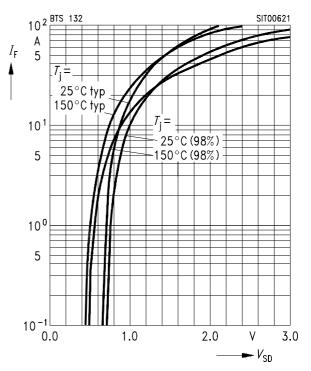
Typ. gate-source leakage current $I_{\text{GSS}} = f(T_{\text{C}})$

Parameter: $V_{GS} = 10 \text{ V}, V_{DS} = 0$

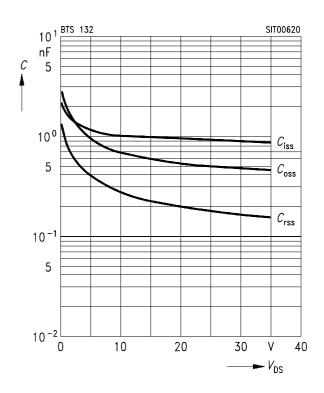


Forward characteristics of reverse diode $I_{\rm F}$ = $f\left(V_{\rm SD}\right)$

Parameter: T_j , $t_p = 80 \ \mu s$ (spread)



Typ. capacitances $C = f(V_{DS})$ Parameter: $V_{GS} = 0, f = 1$ MHz

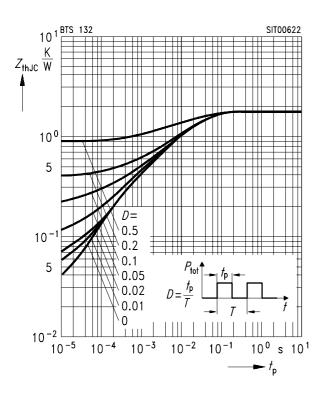




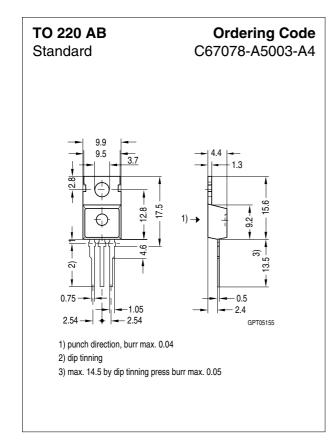


Transient thermal impedance $Z_{\text{thJC}} = f(t_{\text{p}})$

Parameter: $D = t_p/T$









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